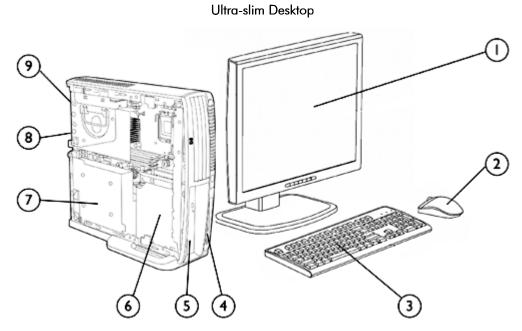
Overview

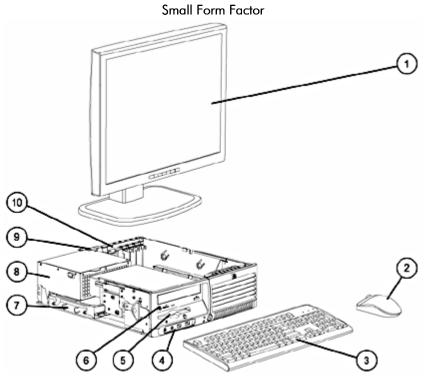


- 1. Monitor (sold separately)
- 2. 2-Button Scroll Mouse (PS/2) or Optical Scroll Mouse (PS/2 or 7. 200-watt Active Power Factor Correction (PFC) power supply USB)
- 3. HP Standard Keyboard (PS/2 or USB) or HP USB Smartcard Keyboard
- 4. Front I/O: (2) USB 2.0, headphone and microphone
- 5. (1) Slimline Drive Bay

- 6. (1) 3.5" internal bay
- 8. (1) full-height PCI slot (with optional riser), (1) low profile PCI Express x16 slot (with optional riser)\*
- 9. Rear I/O: (6) USB 2.0, (1) optional serial port (available via adapter), (1) optional parallel port (available via adapter), (1) optional DVI graphics port (available via DVI ADD2 adapter), (2) PS/2, (1) RJ-45, (1) VGA, audio in/out

\*NOTE: Only one optional riser is allowed: either the PCI riser or the PCI Express x16 riser.

Overview



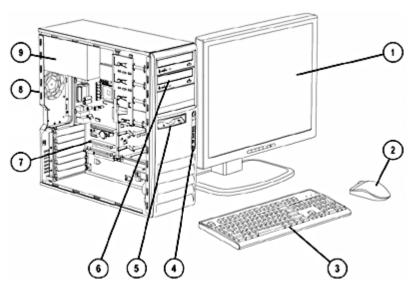
- 1. Monitor (sold separately)
- 2. 2-Button Scroll Mouse (PS/2) or Optical Scroll Mouse (PS/2 or 8. 240-watt Active Power Factor Correction (PFC) power supply USB)
- 3. HP Standard Keyboard (PS/2 or USB) or HP USB Smartcard Keyboard
- 4. Front I/O: (2) USB 2.0, headphone and microphone
- 5. (1) 3.5" external bay for optional HP 16-in-1 Media Card Reader, diskette drive, or other 3.5" device
- device (bay tilts up for device removal and insertion)

- 7. (1) 3.5" internal bay
- 9. Rear I/O: (6) USB 2.0, (1) standard serial port, (1) optional serial port, (1) parallel port, (2) PS/2, (1) RJ-45, (1) VGA, (1) optional DVI graphics port (available via DVI ADD2 adapter), audio in/out
- 6. (1) 5.25" external bay for optional optical drive, or other 5.25" 10. (2) low profile PCI slots, (1) low profile PCI Express x1 slot, (1) low profile PCI Express x16 slot standard\*; (2) full-height PCI slots with optional riser card

\*NOTE: With riser card option, PCI Express x1 and x16 slots are inaccessible.

Overview

### Convertible Minitower



- 1. Monitor (sold separately)
- 2. 2-Button Scroll Mouse (PS/2) or Optical Scroll Mouse (PS/2 or USB)
- 3. HP Standard Keyboard (PS/2 or USB) or HP USB Smartcard Keyboard
- 4. Front I/O: (2) USB 2.0, headphone and microphone
- 5. (1) 3.5" external bay for optional HP 16-in-1 Media Card Reader, diskette drive, or other 3.5" device
- 6. (3) 5.25" external bays and (2) 3.5" internal bays

- 7. (2) full-height PCI slots, (1) full-height PCI Express x1 slot,
  (1) full-height PCI Express x16 slot, (2) additional full-height PCI slots optional
- 8. Rear I/O: 6 USB 2.0, 1 standard serial port, 1 optional serial port, 1 parallel port, 2 PS/2, 1 RJ-45, 1 VGA, audio in/out, mic in
- 9. 365-watt Active Power Factor Correction (PFC) power supply

Overview

### At A Glance

- Designed for long-term, networked deployment within medium and large organizations in commercial business, finance and public sector industries
- Created using industry leading Design for Environment standards. Upgradeable, recyclable and energy efficient.
- Long purchase lifecycles and image stability for demanding enterprise environments
- Support for new Intel technologies introduced in 2006: Intel® Q965 Express chipset, Intel Core™ 2 Duo Processors, and Intel Graphics Media Accelerator 3000 integrated graphics
- Select models with new Intel vPro technology support the latest in manageability and security technology
- Value-added software
  - o HP ProtectTools Security Software Suite, including embedded security, now preinstalled standard
  - o HP Client Manager (http://h18000.www1.hp.com/im/index.html)
  - o HP OpenView Configuration Management Solutions
  - Altiris Deployment Solution Agent
  - O Symantec AntiVirus 10.0 with 60 day Live Update Subscription
  - O HP Insight Diagnostics software
- Fully compatible software OS image across all three models (Ultra-slim Desktop, Small Form Factor, and Convertible Minitower)
- HP BIOS for better security, manageability and software image stability
- Selected configurations with global availability easily set up and ordered through HP.com Business to Business portals (http://h10019.www1.hp.com/business-site/index.html)
- Tailored HP Factory Express deployment and lifecycle services available (http://h71028.www7.hp.com/enterprise/cache/97688-0-0-225-121.aspx)
- Protected by HP Services, including standard warranties up to 5-5-5 (terms and conditions vary by country; certain restrictions and exclusions apply)
- Security
  - Embedded TPM1.2 compliant security module (requires HP ProtectTools Embedded Security software), providing compatibility with future security features expected in Microsoft Vista
  - Redundant Array of Independent Disks (RAID) 1 configurations to protect data against hardware failures
  - HP Backup and Recovery Manager to protect data against software corruption or incompatibilities due to patching or upgrades
- Tool-less serviceability features for easier upgrades and repairs
- Choice of professional chassis form factors to accommodate the desired mix between expandability and size

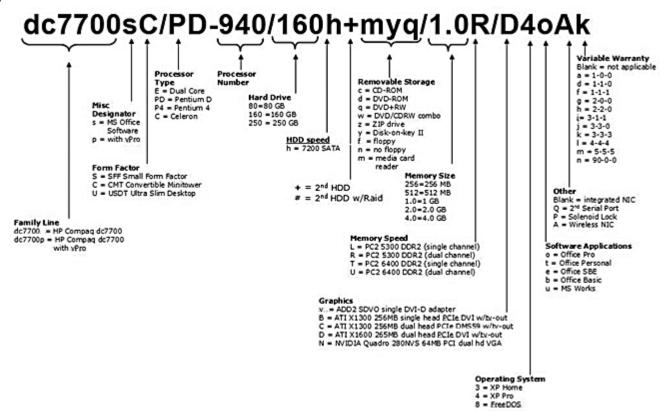
NOTE: All models and features may not be available in all countries.



Configurable Components - Select Models (localized by Regions)

### Model Key and Example

NOTE: This diagram is an example that illustrates how to read the model number. It is not intended to give every available configuration choice specified in the body of this document and may include references to modules that are out of date and no longer available.



### Configurable Components

Operating System – One of the following Genuine Windows XP Professional SP2 Genuine Windows XP Home SP2

FreeDOS

Windows Vista Capable – Not all Windows Vista features are available for use on all Windows Vista Capable PCs. All Windows Vista Capable PCs will run the core experiences of Windows Vista, such as innovations in organizing and finding information, security, and reliability. Some features available in premium editions of Windows Vista -- like the new Windows Aero™ user interface -- require advanced or additional hardware.

Check http://www.windowsvista.com/getready for details.

**NOTE**: Microsoft Windows NT 4.0 and Microsoft Windows 2000 are not available on these systems. Some drivers for Windows 2000 are available for download from http://www.hp.com.

Value-added Software (not included with FreeDOS) HP ProtectTools Security Solutions Microso
Altiris Deployment Solution Agent Microso
HP OpenView Configuration Management Microso

Solutions Agent (visit

http://www.hp.com/go/easydeploy)

HP Insight Diagnostics (on documentation CD)

Computer Setup Utility

HP Backup and Recovery Manager

Symantec AntiVirus 10.0 with 60 day Live Update

Subscription

Microsoft Office 2003 Basic Microsoft Office 2003 Personal

Microsoft Office 2003 Professional

Microsoft Office 2003 Small Business

Microsoft Works 8.5

Microsoft Internet Explorer with Google Toolbar

Adobe Acrobat Reader

**PDF** Complete

Value-added Services and HP Stable Platform Program
Features

Business to Business Portals

Business-to-Business Portals HP Global Series Services Factory Express Deployment and Lifecycle Services

TPM 1.2 Security
Tool-less Serviceability

Service and Support

On-site Warranty and Service Note 1: This three-year (3-3-3), limited warranty and service offering delivers three years of parts, labor and on-site repair. Response time is next business-day Note 2 and includes free telephone support Note 3 24 x 7. Global coverage Note 2 ensures that any product purchased in one country and transferred to another non-restricted country will remain fully covered under the original warranty and service offering. Some countries/regions do not offer one year onsite and labor.

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply.

**NOTE 2:** On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

**NOTE 3**: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.

Ultra-slim Desktop Small Form Factor Convertible Minitower

### Configurable Components

Dimensions			
Chassis Dimensions	2.95 x 12.4 x 13.18 in	3.95 x 13.3 x 14.9 in	17.65 x 6.6 x 17.8 in
(H x W x D)	(7.49 x 31.50 x 33.48 cm)	(10.03 x 33.78 x 37.85 cm)	(44.83 x 16.76 x 45.21 cm)
System weight*	12.08 lb (5.48 kg)	17.18 lb (7.79 kg)	31.18 lb (14.14 kg)
System volume	7.9 liters	12.8 liters	33.8 liters
Shipping weight*	19.20 lb (8.71 kg)	25.10 lb (11.39 kg)	39.5 lb (17.92 kg)
Maximum supported weight (desktop orientation)	77.1 lb (35 kg)	77.1 lb (35 kg)	77.1 lb (35 kg)
Shipping box dimensions	12.63 x 18.75 x 20 in	12.63 x 18.75 x 20 in	23.38 x 13.06 x 22.88 in
(H x W x D)	(32.08 x 47.63 x 50.8 cm)	(32.08 x 47.63 x 50.8 cm)	(59.39 x 33.17 x 58.12 cm)
* Configured with 1 hard di	rive, 1 optical drive, no diskette driv	e, and no PCI card.	
Power Supply	200W power supply – Active PFC	240W power supply – Active PFC	365W power supply – Active PFC
Ports			
USB 2.0	8 (2 front, 6 rear)	8 (2 front, 6 rear)	8 (2 front, 6 rear)
Serial	1 optional via Serial & parallel I/O adapter	1 standard with 2nd optional	1 standard with 2nd optional
Parallel	1 optional via Serial & parallel I/O adapter	1	1
PS/2		1 keyboard, 1 mouse	
Video		analog for integrated graphics	
DVI output	available	via ADD2 card, PCI-E x16 card, or	PCI card
Support for Multi-Monitor	available	via ADD2 card, PCI-E x16 card, or	PCI card
Audio	Front — mic aı Rear — line	Front – mic and headphone Rear – line in, line out, mic in	
NIC (RJ-45)		l 82566DM Gigabit Network Conn	

Chipset	Intel Q965 Express chipset	USDT X	SFF X	CMT X
		USDT	SFF	CMT
Processor and Speed*	Intel Celeron D Processors:	0051	0	Civii
One of the following	Intel Celeron D 326 Processor (2.53-GHz, 256K L2 cache, 533-MHz FSB)	Χ	Χ	Χ
	Intel Celeron D 347 Processor (3.06-GHz, 512K L2 cache, 533-MHz FSB)	Χ	Χ	Χ
	Intel Celeron D 351 Processor (3.20-GHz, 256K L2 cache, 533-MHz FSB)	Χ	Χ	Χ
	Intel Celeron D 352 Processor (3.20-GHz, 512K L2 cache, 533-MHz FSB)	Χ	Χ	Χ
	Intel Celeron D 360 Processor (3.46-GHz, 512K L2 cache, 533-MHz FSB)	Χ	Χ	Χ
	Intel Pentium 4 Processors with Hyper Threading Technology:			
	Intel Pentium 4 524 Processor (3.06-GHz, 1-MB L2 cache, 533 -MHz FSB)	Χ	Χ	Χ
	Intel Pentium 4 531 Processor (3.0-GHz, 1-MB L2 cache, 800-MHz FSB)	Χ	Χ	Χ
	Intel Pentium 4 541 Processor (3.2-GHz, 1-MB L2 cache, 800-MHz FSB)	Χ	Χ	Χ
	Intel Pentium 4 631 Processor (3.0-GHz, 2-MB L2 cache, 800-MHz FSB)	Χ	Χ	Χ
	Intel Pentium 4 641 Processor (3.2-GHz, 2-MB L2 cache, 800-MHz FSB)	Χ	Χ	Χ
	Intel Pentium 4 651 Processor (3.4-GHz, 2-MB L2 cache, 800-MHz FSB)	Χ	Χ	Χ
	Intel Pentium 4 661 Processor (3.6-GHz, 2-MB L2 cache, 800-MHz FSB)	Χ	Χ	Χ
	Intel Pentium D Processors:			





### Configurable Components

Intel Pentium D 820 Processor (2.8-GHz, 2x1MB L2 cache, 800-MHz FSB	Χ	Χ	Χ
Intel Pentium D 915 Processor (2.8-GHz, 2x2MB L2 cache, 800-MHz FSB	Χ	Χ	Χ
Intel Pentium D 925 Processor (3.0-GHz, 2x2MB L2 cache, 800-MHz FSB)	Χ	Χ	Χ
Intel Pentium D 945 Processor (3.4-GHz, 2x2MB L2 cache, 800-MHz FSB)	Χ	Χ	Χ
Intel Core 2 Duo Processors:			
Intel Core 2 Duo E6300 Processor (1.86-GHz, 2 MB L2 cache, 1066-MHz FSB)	Χ	Χ	Χ
Intel Core 2 Duo E6400 Processor (2.13-GHz, 2 MB L2 cache, 1066-MHz FSB)	Χ	Χ	Χ
Intel Core 2 Duo E6600 Processor (2.40-GHz, 4 MB L2 cache, 1066-MHz FSB)	Χ	Χ	Χ
Intel Core 2 Duo E6700 Processor (2.66-GHz, 4 MB L2 cache, 1066-MHz FSB)	Χ	Χ	Χ

\*NOTE: Intel processor numbers are not a measure of performance. Processor numbers differentiate features within each processor family, not across different processor families.

USDT SFF CMT

Intel vPro Technology\*

Uses AMT 2.0 (Active Management Technology) for network alerting and management of systems regardless of power state, as well as operating system-absent environments

\*NOTE: Units configured with this feature are referred to as HP Compag dc7700p Business PCs.

#### Memory

### DDR2 SYNCH DRAM NON-ECC MEMORY

Memory upgrades are accomplished by adding single or multiple DIMMs of the same or varied sizes. This chart does not represent all possible memory configurations. The Intel Q965 Express chipsets support non-ECC DDR2 PC2-5300 (667-MHz) and PC2-6400 (800-MHz) memory.

**CAUTION:** You must shut down the computer **and disconnect the power cord** before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

#### HP recommends dual-channel symmetric configurations for maximum performance.

For best performance, add the same amount of total memory to each channel and do not mix speeds. For dual-channel symmetric performance, the total amount of memory in each channel must be equal. If speeds are mixed, speed will default to the slowest DIMM.

### Ultra-slim Desktop

Maximum Memory\*

Supports up to 3-GB of DDR2 SYNCH DRAM. Slot 1 is black and must always be populated. Not all memory configurations possible are represented below.

### Configurable Components

DIMM Size	Slot				
	Char	Channel B			
	1 (black)	3 (white)			
512-MB	512-MB				
512-MB (dual-channel	256-MB		256-MB		
symmetric)					
1-GB	1-GB				
1-GB (dual channel symmetric)	512-MB		512-MB		
3-GB maximum	1-GB	1-GB	1-GB		

\*NOTE: The Intel Q965 Express chipset includes a built-in Management Engine (ME), which allocates memory for manageability functions. Management Engine memory is shared with system memory. If the PC contains a single DIMM, 8 MB of memory is preallocated for it at system startup. If the PC contains two DIMMs, 16 MB of memory is pre-allocated. This memory is not made available to the operating system, just as pre-allocated video memory is not available.

### Small Form Factor and Convertible Minitower

Maximum Memory\*

Supports up to 4-GB of DDR2 SYNCH DRAM. Slot 1 is black and must always be populated. Not all memory configurations possible are represented below.

NOTE: Above 3-GB, all memory may not be available due to system resource requirements.

DIMM Size	Slot				
	Cha	ınnel A	Cho	annel B	
	1 (black)	2 (white)	3 (white)	<b>4</b> (white)	
512-MB	512-MB				
512-MB (dual-channel symmetric)	256-MB		256-MB		
1-GB	1-GB				
1-GB (dual-channel symmetric)	512-MB		512-MB		
1-GB (dual-channel symmetric)	256-MB	256-MB	512-MB		
2-GB (dual-channel symmetric)	1-GB		512-MB	512-MB	
2-GB (dual-channel symmetric)	512-MB	512-MB	512-MB	512-MB	
4-GB maximum (dual-channel symmetric)	1-GB	1-GB	1-GB	1-GB	

\*NOTE: The Intel Q965 Express chipset includes a built-in Management Engine (ME), which allocates memory for manageability functions. Management Engine memory is shared with system memory. If the PC contains a single DIMM, 8 MB of memory is preallocated for it at system startup. If the PC contains two DIMMs, 16 MB of memory is pre-allocated. This memory is not made available to the operating system, just as pre-allocated video memory is not available.

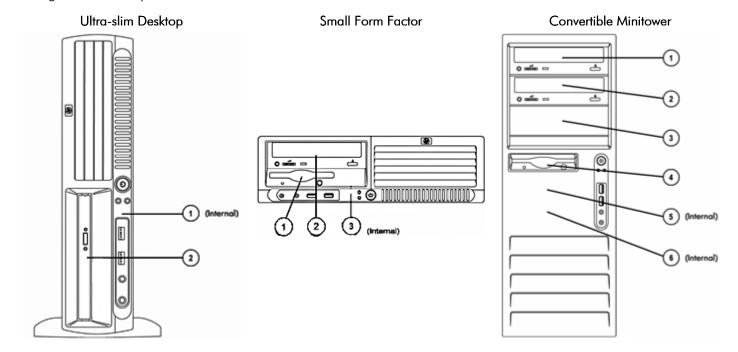
### Configurable Components

Memory Configurations -
One of the following

-	USDT	SFF	CMT
512-MB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (1 x 512)	Χ	Χ	Χ
512-MB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (2 x 256)	Χ	Χ	Χ
1-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (1 x 1GB)	Χ	Χ	Χ
1-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (2 x 512)	Χ	Χ	Χ
2-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (2 x 1GB)	Χ	Χ	Χ
2-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (4 x 512)		Χ	Χ
3-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (3 x 1GB)	Χ	Χ	Χ
4-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (4 x 1GB)		Χ	Χ
512-MB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (1 x 512)	Χ	Χ	Χ
512-MB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (2 x 256)	Χ	Χ	Χ
1-GB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (1 x 1GB)	Χ	Χ	Χ
1-GB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (2 x 512)	Χ	Χ	Χ
2-GB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (2 x 1GB)	Χ	Χ	Χ
2-GB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (4 x 512)		Χ	Χ
3-GB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (3 x 1GB)	Χ	Χ	Χ
4-GB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (4 x 1GB)		Χ	Χ

Expandability	USDT	SFF	CMT
PCI slots	Optional with riser card: 1 full-height (4.2"), length (6.6")	2 low-profile (2.5"), length (6.6") standard; 2 full-height (4.2"), length (6.875") via optional riser card. NOTE: With riser card option, express x1 and x16 slots are not accessible.	2 full-height (4.2"), length (13.4") standard; (2 additional full-height slots available via optional extender card)
Max power per slot	25W	25W	25W
PCI Express x16 slot	Optional with riser card: 1 low-profile (3.987"), length (6.60")	1 low-profile (2.5"), length (6.6")	1 full-height (4.2"), length (10.5")
Max power per slot	25W	25W	75W
PCI Express x1 slot		1 low profile (2.5"), length (6.6")	1 full-height (4.2"), length (13.4")
Max power per slot	N/A	10W	10W
External Bays	1 Slimline (WxDxH): 128 x 127 x 12.7 mm	2	4
3.5"	N/A	1	1
5.25"	N/A	1 (length 8.189")	3 (2 – length 8.189", 1 – length 5.71")
Internal 3.5" HDD Bays	1	1	2
Hard Drive Controller (PCI) Supported	Serial ATA (sup	port for SATA 1.5-Gb/s and 3.0-G	b/s hard drives)
Hard Drive Interfaces Supported	1 Serial ATA interface	3 Serial ATA interfaces	4 Serial ATA interfaces

### Configurable Components



### Storage – Drive Support

	US	DT	SFF			CMT			
	Slimline Drive Bay	3.5" Serial ATA Hard Drive	Diskette Drive or PCI Media Card Reader (optional)	Storage Drive Bay	3.5" Serial ATA Hard Drives	Diskette Drive	PCI Media Card Reader (optional)		3.5" Serial ATA Hard Drives
Quantity Supported	1	1	1	1	2	1	1	3	3
Position Supported	2	1	1	2	1,3	4	(1), (1), (2), (3)	①,②, ③	(4) (5), (6)
Controller	SATA to IDE Bridge	SATA	Diskette Controller or USB header on PCI card	SATA	SATA	Diskette Controller	USB header on PCI card	SATA	SATA

## Configurable Components

		USDT	SFF	СМТ
Hard Drive –	80-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm)	Χ	Χ	Χ
One or two of the	160-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm)	Χ	Χ	Χ
following	250-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm)	Χ	Χ	Χ
	RAID 80-GB SATA 3.0-Gb/s Hard Drive (7200 rpm)		Χ	Χ
	RAID 160-GB SATA 3.0-Gb/s Hard Drive (7200 rpm)		Χ	Χ
	RAID 250-GB SATA 3.0-Gb/s Hard Drive (7200 rpm)		Χ	Χ
	2nd hard drive, 80-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm)		Χ	Χ
	2nd hard drive, 160-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm)		Χ	Χ
	2nd hard drive, 250-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm)		Χ	Χ
Removable Storage –	Diskette Drives			
One or more of the	1.44-MB Diskette Drive		Χ	Χ
following depending on form factor (see Storage section below)	Optical Drives			
	SATA CD-ROM Drive		Χ	Χ
	SATA CD-RW/DVD-ROM Combo Drive		Χ	Χ
	SATA DVD-ROM Drive		Χ	Χ
	SATA DVD+/-RW (DL/DF) LightScribe Drive		Χ	Χ
	Slimline Optical Drives			
	PATA CD-ROM Slim Drive	Χ		
	PATA CD-RW/DVD-ROM Combo Slim Drive	Χ		
	PATA DVD+/-RW Slim Drive	Χ		
	PATA DVD-ROM Slim Drive	Χ		
Media Card Reader –	HP 16-in-1 3.5" Media Card Reader w/ PCI card		Χ	
One of the following	HP 16-in-1 5.25" Media Card Reader w/ PCI card			Χ
Security	Integrated 1.2 TPM Embedded Security Chip	Χ	Х	Х
	Drive Lock	Χ	Χ	Χ
	HP ProtectTools Embedded Security Software	Χ	Χ	Χ
	Serial, Parallel, USB Enable/Disable (via BIOS)	Χ	Χ	Χ
	Removable Media Write/Boot Control	Χ	Χ	Χ
	Power-On Password (via BIOS)	Χ	Χ	Χ
	Setup Password (via BIOS)	Χ	Χ	Χ
	Solenoid Hood Lock / Sensor		Χ	Χ
	Hood Removal Sensor	Χ		



Configurable (	Components			
NIC	Intel 82566DM Gigabit Network Connection (integrated on system board) Intel PRO/1000 PT PCIe Gigabit NIC (full height bracket)	Х	Χ	X X
	Intel PRO/1000 PT PCIe Gigabit NIC (low profile bracket)		Χ	
	Broadcom NetXtreme Gigabit PCIe NIC (full height bracket)			Χ
	Broadcom NetXtreme Gigabit PCle NIC (low profile bracket)	Χ*	Χ	
	NOTE: * Requires optional PCIe riser card.			
Wireless	Wireless A+G PCI Card (full height bracket)	Χ*	Χ*	Χ
	Wireless A+G PCI Card (low profile bracket)		Χ	
	NOTE: : *Requires optional PCI riser card.			
Modem	Agere 2006 PCI 56K International SoftModem (full height)	X*	X*	Χ
	Agere 2006 PCI 56K International SoftModem (low profile)		Χ	
	NOTE: *Requires optional PCI riser card.			
Graphics	Integrated Intel Graphics Media Accelerator 3000	Х	Х	Х
·	DVI ADD2 SDVO single head Graphics Adapter for USDT (PCle x16)	Χ		
	DVI ADD2 SDVO single head low profile Graphics Adapter (PCle x16)		Χ	
	DVI ADD2 SDVO single head full-height Graphics Adapter (PCle x16)			Χ
	ATI Radeon X1300 (256MB SH) low profile PCIe Card, DVI w/TV	Χ*	Χ	
	ATI Radeon X1300 (256MB SH) full-height PCle Card, DVI w/TV			Χ
	ATI Radeon X1300 Pro (256MB DH) low profile PCle Graphics Card	Χ*	Χ	
	ATI Radeon X1300 Pro (256MB DH) full-height PCle Graphics Card			Χ
	ATI Radeon X1600XT (256MB DH) full-height PCle Card, DVI w/TV-out			Χ
	NVIDIA Quadro NVS 280 (64MB DH) PCI VGA Card	X**	X***	X***
	NVIDIA Quadro NVS 285 (128MB DH) PCIe x16 VGA Card	Χ*	X***	X***
	NOTES:			
	* USDT requires optional PCI riser card.			
	** USDT requires optional PCI riser card.  *** NVIDIA Quadro NVS 285 and NVS 280 graphics cards can be			
	combined to provide support for four monitors.			



Cont	figural	ole (	Compo	nents

Audio	Integrated High Definition audio with Realtek 4-channel ALC262 codec (all ports are stereo)	Χ	Χ	Χ
	Microphone and Headphone front ports	Χ	Χ	Χ
	Microphone rear port*			Χ
	Line-out and Line-In rear ports*	Χ	Χ	Χ
	Multistreaming capable*	Χ	Χ	Χ
	Internal Speaker	Χ	Χ	Χ
	NOTE: *Rear audio ports are re-taskable as Line-in, Line-out, or Microphone-in. Expenses be powered externally. Multistreaming can be enabled in the Realtek control panel audio streams to be sent to/from the front and rear jacks. This allows for different couse separate audio ports on the system. For example, the front jacks could be used communications application while the rear jacks are being used with external speal application.	to allov udio ap with a	w indepo oplication headse	endant ons to t for a
Keyboard –	HP PS/2 Standard Keyboard	Χ	Χ	Χ
One of the following	HP USB BG1650 Keyboard	Χ	Χ	Χ
	HP USB Standard Keyboard	Χ	Χ	Χ
	HP USB Smartcard Keyboard	X	Х	X
Mouse –	HP PS/2 2-Button Scroll Mouse	Χ	Χ	Χ
One of the following	HP PS/2 2-Button Optical Scroll Mouse	Χ	Χ	Χ
	HP USB 2-Button Optical Scroll Mouse	Х	Х	Χ
Miscellaneous	HP FireWire / IEEE 1394 PCI Card (full height)	X*	Χ*	Χ
	HP FireWire / IEEE 1394 PCI Card (low profile)		Χ	
	PCI Express riser card – adds 1 low profile PCIe x16 slot	Χ		
	PCI riser card – adds 1 full-height PCI slot	Χ		
	PCI riser card – adds 2 full-height PCI slots NOTE: Low profile slots are unusable with riser card installed.		Χ	
	PCI extender card for CMT (adds 2 PCI slots)			Χ
	PCI Serial and parallel I/O adapter	Χ*		
	2nd serial port adapter (full height)			Χ
	2nd serial port adapter (low profile)		Χ	

NOTE: \*Requires optional PCI riser card.

Configure dc7700 CMT in desktop orientation

Tower stand



Χ

Χ

Χ

After-Market Options (availability may vary by region)

		USDT	SFF	СМТ	After-Market Options Part Number
Communications	Wireless				
	HP Wireless A+G PCI Card (North America only)	X*	Χ	Χ	EA118AA
	HP Wireless A+G PCI Card (WW except North America)	X*	Χ	Χ	PZ928AA
	HP BT450 USB Bluetooth Wireless Printer and PC Adapter	Χ	Χ	Χ	IPQ639A
	NICs				
	Broadcom NetXtreme Gigabit Ethernet PCle NIC Card	X**	Χ	Χ	EA833AA
	Intel/PRO 1000 PT PCIe Gigabit NIC Card	X**	Χ	Χ	EH352AA
	Modem				
	Agere 2006 PCI 56K International SoftModem NOTES:  * USDT requires optional PCI riser card.  ** USDT requires optional PCIe riser card.	X*	X	X	EK694AA
Graphics	Single head solutions				
	Intel DVI ADD2 Graphics Adapter (PCle x16)		Χ	Χ	DY674A
	ATI Radeon X1300 (256MB SH) PCIe Graphics Card	X**	Χ	Χ	AG392AA
	Multi head solutions				
	ATI Radeon X1300 Pro (256MB DH) PCle Graphics Card	X**	Χ	Χ	AH050AA
	NVIDIA Quadro NVS 280 PCI Graphics Card (DMS59 DVI Dual-head Connector Cable)	Χ*	Χ	Χ	DY599A
	NVIDIA Quadro NVS 285 (128MB DH) PCle x16 VGA Card	X**	Χ	Χ	RD069AA
	HP DMS59 DVI Dual-head Connector Cable***		Χ	Χ	DL139A
	NOTE: *Requires optional PCI riser card.  ** USDT requires optional PCIe riser card.  *** Requires NVIDIA Quadro NVS 280 PCI Graphics				
Hard Drives	Serial ATA Hard Drives				
	HP 80-GB SATA 3.0-Gb/s Hard Drive	Χ	Χ	Χ	PY276AA
	HP 160-GB SATA 3.0-Gb/s Hard Drive	Χ	Χ	Χ	PY277AA
	HP 250-GB SATA 3.0-Gb/s Hard Drive	Χ	Χ	Χ	PY278AA



Input/Output Devices	Keyboards				
1 / - 1	HP PS/2 Standard Keyboard	Χ	Χ	Χ	DT527A
	HP USB Standard Keyboard	Χ	Χ	Χ	DT528A
	Pointing Devices				
	HP PS/2 2-Button Scroll Mouse	Χ	Χ	Χ	DD440B
	HP PS/2 2-Button Optical Scroll Mouse	Χ	Χ	Χ	EY703AA
	HP USB 2-Button Optical Scroll Mouse	Χ	Χ	Χ	DC172B
Memory (DIMMs)	PC2-5300 (DDR2, 667 MHz) DIMMs Non-ECC				
, , , ,	HP 1 GB PC2-5300 (DDR2-667) DIMM	Χ	Χ	Χ	PX976AA
	HP 512 MB PC2-5300 (DDR2-667) DIMM	Χ	Χ	Χ	PX975AA
	HP 256 MB PC2-5300 (DDR2-667) DIMM	Χ	Χ	Χ	PX974AA
	PC2-6400 (DDR2 800) MHz) DIMMs				
	HP 1-GB PC2-6400 (DDR2 800 MHz) DIMM	Χ	Χ	Χ	AH058AA
	HP 512-MB PC2-6400 (DDR2 800 MHz) DIMM	Χ	Χ	Χ	AH056AA
	HP 256-MB PC2-6400 (DDR2 800 MHz) DIMM	Χ	Χ	Χ	AH054AA
Monitors	TFTs				
	HP L1506 15 TFT Flat Panel Monitor – Analog only	Χ	Χ	Χ	PX848AA#ABA
	HP L1706 17 TFT Flat Panel Monitor – Analog only	Χ	Χ	Χ	PX849AA#ABA
	HP L1740 17 TFT Flat Panel Display – Analog/Digital	Χ	Χ	Χ	PL766AA#ABA
	HP L1755 17 TFT Flat Panel Display – Analog/Digital	Χ	Χ	Χ	PL777AA#ABA
	HP L1906 19 TFT Flat Panel Display – Analog only	Χ	Χ	Χ	PX850AA#ABA
	HP L1940T 19 TFT Flat Panel Display – Analog/Digital	Χ	Χ	Χ	EM869AA#ABA
	HP L1955 19 TFT Flat Panel Display – Analog/Digital	Χ	Χ	Χ	PD974AA#ABA
	HP L2065 20 TFT Flat Panel Display – Analog/Digital	Χ	Χ	Χ	EF227A4#ABA
	HP LP2465 24 TFT Widescreen Flat Panel Display – Analog/Digital	Χ	Χ	Χ	EF224A4#ABA
	CRTs				
	HP s7540 17 (16.0 vis) CRT Monitor	Χ	Χ	Χ	PF997AA#ABA
	HP v7650 17 (16.0 vis) Flat-face CRT Monitor	Х	Х	X	PF996AA#ABA
Multimedia	HP USB Powered Speakers	Χ	Χ	Χ	RD628AA
PATA Slim Optical Drives	DVD-ROM Drive				
	HP PATA DVD-ROM Slim Drive	Χ			AH041AA
	Combo Drive  HP PATA CD-RW/DVD-ROM Combo Slim Drive  DVD+/-RW Drive	Χ			AH042AA
	HP PATA DVD+/-RW (DL/DF) LightScribe Slim Drive	Χ			AH043AA



After-Market Options	(availability may vary by region)						
SATA Half-Height Optical	DVD-ROM Drive						
Drives	HP SATA DVD-ROM Drive		Χ	Χ	AH047AA		
	Combo Drive						
	HP SATA CD-RW/DVD-ROM Combo Drive		Χ	Χ	AH046AA		
	DVD+/-RW Drive						
	HP SATA DVD+/-RW (DL/DF) LightScribe Drive		Χ	Χ	AH048AA		
Removable Storage	Drive Key Options						
J	HP 512MB USB 2.0 Drive Key	Χ	Χ	Χ	ED516AA		
	HP 1GB USB 2.0 Drive Key	Χ	Χ	Χ	AG382AA		
	Diskette and Digital Drives						
	HP 1.44-MB External USB Diskette Drive	Χ	Χ	Χ	DC141B		
	HP 1.44-MB Internal Diskette Drive	,	X	X	DS710G		
	Multimedia		,,	,,	20, 100		
	HP 16-in-1 Media Card Reader with PCI Card		Χ	Χ	EM718AA		
Security	Kensington Lock	Х	Х	Х	PC766A		
	HP Business PC Security Lock	Х	Χ	Χ	PV606AA		
	HP USB Biometric Fingerprint Reader	Χ	Χ	Χ	EM717AA		
	HP (USDT) Wall Mount Security Sleeve*	Χ		•	PA719A		
	HP (SFF) Wall Mount Security Sleeve**	,	Χ		PA717A		
	HP USB Smartcard Keyboard	Χ	X	Χ	ED707AA		
	NOTES:	,,	,,	,,	25, 0,,,,		
	* Dimensions (W x H x L): $12.7 \times 3.5 \times 12.0$ inches; Weight: $3.8$ lb ** Dimensions (W x H x L): $13.5 \times 4.4 \times 14.4$ inches; Weight: $5.9$ lb						
Software	HP OpenView Client Configuration Manager	Х	X	X	T3488AA (use T3489AA for 1000 licenses)		
	HP Client Foundation Suite	Χ	Χ	Χ	EF117AA		
	Includes:	^	^	٨	(use EF118AA for		
	HP Client Manager HP Systems Insight Manager Connector Altiris Local Recovery Pro				1000+ licenses)		
	Altiris Inventory Solution Altiris Deployment Solution						
	HP Client Premium Suite	Χ	Χ	Χ	EF119AA		
	Includes: HP Client Manager HP Systems Insight Manager Connector HP OpenView Connector Altiris Connector Solution Altiris Local Recovery Pro	^	^	٨	(use EF120AA for 1000+ licenses)		
	Altiris Audit Express Altiris Client Management Suite Level 1						



After-Market Options (availability may vary by region)

Brackets/Stands	HP Integrated Work Center Stand	Χ			DL641B
	Tower Stand		Х		PS797A
Miscellaneous	HP Serial & Parallel IO Adapter	Χ			PD825A
Accessories	HP 2nd Serial Port		Χ	Χ	PA716A
	HP (50 Pk) 5.25" Blank Bezel Kit		Χ	Χ	DC177B
	HP (USDT) PCI Riser Board	Χ			ED247AA
	HP (USDT) PCIe x16 Riser Board	Χ			EU054AA
	HP (SFF) PCI Riser Board		Χ		PD824A
	HP PCI Extender			Χ	DC179B
	HP FireWire / IEEE 1394 PCI Card	X*	Χ	Χ	PA997A
	Belkin USB to Serial Adapter	Χ	Χ	Χ	EM449AA
	NOTE: *Requires optional PCI riser card.				



### Technical Specifications

Unit Environment and	Ultra-slim Desktop	Small Form Factor	Convertible Minitower
Operating Conditions			

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's recirculated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign
  matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range	Operating: 50° to 95° F (10° to 35° C)*	
	Non-operating: -22° to 140° F(-30° to 60° C)	
Relative Humidity	Operating: 10% to 90% (non-condensing at ambient)	
·	Non-operating: 5% to 95% (non-condensing at ambient)	
Maximum Altitude	Operating: 10,000 ft (3048 m)	
(unpressurized)	Non-operating: 30,000 ft (9144 m)	

\*NOTE: Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Power Supply	Ultra-slim Desktop	Small Form Factor	Convertible Minitower
Power Supply		240 watt custom power supply –	
	Active PFC)	Active PFC	Active PFC)
Operating Voltage Range	90 – 264 VAC	90 – 264 VAC	90 – 264 VAC
Rated Voltage Range	100 – 240 VAC	100 – 240 VAC	100 – 240 VAC
Rated Line Frequency	50/60 Hz	50/60 Hz	50/60 Hz
Operating Line Frequency Range	47 – 63 Hz	47 – 63 Hz	47 – 63 Hz
Rated Input Current	4A	5A	6A
System Heat Dissipation	Typical 340 btu/hr (86 kg-cal/hr) Maximum 1050 btu/hr (265 kg-cal/hr)	Typical 340 btu/hr (86 kg-cal/hr) Maximum 1260 btu/hr (318 kg-cal/hr	Typical 375 btu/hr (95 kg-cal/hr) Maximum 1916 btu/hr (483 kg-cal/hr)
Power Supply Fan	70mm variable speed	80mm variable speed	92mm variable speed
Energy Star 3.0 Compliant	X	X	X
FEMP Standby Power Compliant (<2W in S5 – Power Off)**	X	X	X
Power Consumption in ES Mode – Suspend to RAM (S3) (Instantly Available PC)	< 3W	< 3W	< 3W
Environmental and Mechanical Engineering Support Center (EMESC) – Intranet Web Site only		ebserver.ccm.cpqcorp.net/EMESC	C/default.htm

\*\*NOTE: Power consumption in the Off/Apparent Off mode is measured and reported with the network interface controller "Wake on LAN" feature disabled in F10 Setup (default is "enabled").



### Technical Specifications

### **ROM BIOS Information**

Key features of the HP BIOS in the dc7700 include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP Business desktop computer into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 12 languages. Select models offer Intel vPro technology including AMT (Active Management Technology).
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- Security HP BIOS Configuration for ProtectTools offers a robust and flexible set of security features to help the system administrator secure their systems from removal of sensitive data, and help prevent access by unauthorized users.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies to assist in operating the HP Business Desktop computer in any enterprise environment.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within DOS (Flashlite), BIOS updates from within Windows (HPQFlash, SSM), HP Client Manager, and fail-safe recovery. In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available from within the BIOS software and from the support website.

#### Additional HP BIOS Features

- Power-On password Helps prevent an unauthorized user from powering on the system. After a TPM Basic User password is established in windows, the user or admin can require TPM hardware based authentication during the power-on process.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system
  configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be made
  to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and configuration management, allowing operating systems and applications to manage power based on activity and usage. HP Compaq dc7700 models use ACPI to provide power conservation features under Windows XP.

Other Features	Description
ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI).
	<ul> <li>Allows the system to wake from a low power mode.</li> <li>Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.</li> </ul>
SMBIOS Ver. 2.4	System Management BIOS, previously known as DMI BIOS, for system management information
Wired for Management Support	Intel-driven, industry-wide initiative to make Intel architecture-based PCs, servers and mobile computers more inherently manageable right out of the box and over the network
Dual-State Power Button	Power button acts as both an on/off button and suspend-to-sleep button

## Technical Specifications

C . I.I. E		
Serviceability Features of System		
Dual Color Power LED on Front of Con	nputer (Indicates Normal Operations and Fau	It Conditions)
Diagnostic LED Explanation Table	Number of 1-second red LED blinks follower 2-processor thermal protection activated 3-processor not installed 4-power supply failure 5-memory error 6-video error 7-PCA failure (ROM detected failure prior to 8-invalid ROM, bootblock recover mode	
System/Emergency ROM	• Flash ROM	CMOS Battery Holder for easy     Replacement
Flash Recovery with Video     Configuration Record SW	5 Aux Power LED on System PCA	Processor ZIF Socket for easy Upgrade
Over-Temp Warning on Screen (Requires IM Agents)	Clear Password Jumper	DIMM Connectors for easy Upgrade
HP Backup and Recovery     Manager	Clear CMOS Button	NIC LEDs (integrated) (Green & Amber)

Serviceability Features of Chassis				
Dual Color Power and HD LED – To Indicate Normal Operations and Fault Conditions	Color coordinated cables and connectors	Tool-less Hood Removal		
Front power switch	<ul> <li>System memory can be upgraded without removing the system board or any internal components</li> </ul>	<ul> <li>Tool-less Hard Drive, CD &amp; Diskette Removal</li> </ul>		
Green Pull Tabs, and Quick Release Latches for easy Identification		Tool-less System Board Removal		
NOTE: Thumb screw release mechanism	n is used with the Ultra-slim Desktop chassis co	ver.		
Feature	Description			
AMT 2.0 support (Active Management Technology)	Select models offer new Intel vPro Technology utilizing AMT 2.0 for network alerting and management of systems regardless of power state, as well as operating system-absent environments.			
ASF 2.0 support (Alert Standard Format	Industry-standard specification for network ale	rting in operating system-absent environments		
Tower	Product can be oriented as a tower (in addition			
Drive Lock*	Implementation of the industry standard ATA S software access to user data on the drive until provided.			
Drive Self Tests (DPS)*  DPS Access through F10 Setup during Boot	<ul> <li>Running independently of the operating Windows-based diagnostics utility or thr produces an evaluation on whether the needs to be replaced.</li> <li>The system expands on the Self-Monitor</li> </ul>	ts and then reports any faults to the user.		



### Technical Specifications

SMART Technology* (Self-Monitoring, Analysis and Reporting	Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted
Technology) SMART I – Drive Failure Prediction	Predicts failures before they occur. Tracks fault prediction and failure indication
SMART II – Off-Line Data Collection	parameters such as re-allocated sector count, spin retry count, calibration retry count
SMART III – Off-Line Read Scanning with Defect Reallocation	<ul> <li>By avoiding actual hard drive failures, SMART hard drives act as "insurance" against unplanned user downtime and potential data loss from hard drive failure</li> </ul>

NOTE: This feature is inoperable when a RAID (Redundant Array of Independent Disks) configuration is enabled.



### Technical Specifications - Audio

**High Definition Audio** Type Integrated

High Definition Stereo

Codec

Yes – Realtek ALC262, 4-channel

**Audio Jacks** Microphone-In (64-K ohm Input Impedance); front and rear stereo analog

microphone ports available except for USDT and SFF, which has front stereo

microphone only

Line-In (64-K ohm Input Impedance)

Line-Out \* (200 ohms Output Impedance, expects at least a 10-K ohm load)

Headphone-Out (1 Ohm Output Impedance, expects at least a 32 ohm

1.5 W

Yes

Yes

NOTE: \*Internal Speaker Amplifier is for Internal Speaker only. External Speakers need to be powered externally. Rear audio ports are re-taskable as Line-in, Line-out, or Microphone-in.

Multistreaming Capable Multistreaming can be enabled in the Realtek control panel to allow

independent audio streams to be sent to/from the front and rear jacks.

8 kHz - 192 kHz Sampling

Wavetable Syntheses

(software)

Yes – Uses OS soft wavetable

Analog Audio Yes

Number of Channels on

Stereo (Left & Right channels)

Line-Out (mono/stereo)

Internal Audio Speaker

**Power Rating** 

Internal Speaker External Speaker Jack

(Line-Out)

### Technical Specifications - Communications

Integrated Intel 82566DM Connector RJ-45

Gigabit Network
Connection

Controller Intel Nineveh Gigabit platform LAN Connect Networking Controller

Memory Integrated 96KbB on chip buffer memory

Data rates supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3 ab and 802.3u compliant,

Bus architecture GLCI, LCI interface. Intel specific MAC to PHY interface

Data transfer mode At gigabit GLCI (802.3 serdes) is for Data, LCI (parallel bus) for MDIO, at

10/100 LCI for both data and MDIO, GLCI is idle.

Hardware certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark

for European Union

**Power requirement** Require 3.3Vaux, 1.8V and 1.0V or just 3.3V with integrated regulators

Power consumption 1.16 Watts for 82566, whole LOM 2.53 Watts

ACBS Intel Auto Connect Battery Saving feature

Boot ROM support Yes

Network transfer mode Full-duplex

Half-duplex (not available for the 1000BASE-T transceiver)

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Environmental Operating temperature 32° to 131°F (0° to 55° C)

To 70° C for external regulator

Operating humidity 85% at 131° F (55° C)

Operating system driver

support

Microsoft 2000, Microsoft XP

Management capabilities WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable

diagnostic.

Alerting ASF 2.0 support, AMT 2.0 support on dc7700p models with Intel vPro

Technology

### Technical Specifications - Communications

Intel PRO/1000 PT PCIe Connector Gigabit NIC Controller

Connector RJ-45

Controller Intel 82572El Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data rates supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant,

802.3x flow control

Bus architecture PCI-E 1.0a

Data transfer mode Bus-master DMA

Hardware certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark

for European Union

Power requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM support Yes

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps

1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI Bus)

Operating temperature 32° to 131°F (0° to 55° C)

Environmental Operating temperature 32° to 131°F (0° to 55° 0

Operating humidity 85% at 131° F (55° C)

Dimensions 6.4 x 2.6 x 0.8 in (16.3 x 6.6 x 1.9 cm)

Operating system driver

support

Microsoft 2000, Microsoft XP

Management capabilities ASF, WOL, PXE, DMI, WFM 2.0.

HP Wireless A+G PCI Dimen

Dimensions 4.99 x 2.54 x 0.71 in (126.8 x 64.4 x 18.0 mm)

**Weight** 0.268 lb (65 g)

Controller Atheros AR5414X chipset

system interface PCI Spec 2.2

Network standard IEEE 802.11a/b/g

Frequency band 5.1500 to 5.8500 GHz
2.4000 to 2.4835 GHz

2.4465 to 2.4835 GHz (Europe, Middle East, Asia and Asia Pacific -

excluding Japan)

2.4000 to 2.4697 GHz (Japan)

Operating temperature 32° to 140° F (0° to 60° C), operating

Storage temperature  $-4^{\circ}$  to  $176^{\circ}$  F (-20° to  $80^{\circ}$  C), non-operating

Humidity 10% to 85% non-condensing

Operating voltage  $5V \pm 5\%$ 

Power consumption Tx/Rx peak 560/250mA @ 3.3V (max.)

Output power 15 dBM ±2dB

(approximately)

Receive sensitivity -90dBm at 11 Mbps (typical)

**Data transfer rate** Standard rates of 1, 2, 5.5, 11, 6, 9, 12, 18, 24, 48, 54 and Super AG

Mode 108-Mbps



### Technical Specifications - Communications

Spreading DSSS (Direct Sequence Spread Spectrum)

Security 64(40h) bit, 128(104h) bit, WPA, IEEE802.1X, AES-OCB, AES-CCM,

Microsoft PEAP, TKIP, WEP.

Antenna External 5dBi antenna

Throughput 108 Mbps (only with Belkin 54G or 200 ft (60.96 m) – Indoor

above router that supports 108 Mbps

speed)

54 Mbps 200 ft (60.96 m) – Indoor 11 Mbps 200 ft (60.96 m) – Indoor

Certifications Wi-Fi certified

Certifications for use by North America: United States, Canada

country

Europe: Austria, Belgium, Cyprus, Denmark, Finland, France, Germany, Greece, Iceland, Ireland, Italy, Liechtenstein, Luxembourg, Netherlands,

Norway, Portugal, Spain, Sweden, Switzerland, United Kingdom

Australia New Zealand

OS support Microsoft Windows 2000 (Service Pack 4 or greater), Windows XP Home,

Windows XP Professional

Agere 2006 PCI 56K International SoftModem Data Transmission

Technology speeds: 56,000 Kbps maximum downstream data, controllerless

**NOTE**: 56 Kbps technology refers to download speeds only and requires compatible modems at server sites. Other conditions may limit modem speed. FCC limitations allow a maximum of 53 Kbps during download transmissions.

Data Speeds (Upload only)

33,600/31,200/28,800/26,400/21,600/19,200/16,800/14,400/12,000/

9,600/7,200/4,800/2,400/1,200/300

Data Standards ITU-T V.90, ITU-T, ITU-T V.34, V.44, V.42, V.42bis21, V.32bis, Bell 212A,

and Bell 103

Fax Speeds 14,400/12,000/9,600/7,200/4,800/2,400/1,200/300 b/s

Fax Mode Capabilities ITU-T T.31 class 1 FAX, V. 17, V.29, V.27ter, and V.21 Channel 2

Error Correction and Data Compression

V.44, 42bis, V.42 and MNP2-5

Power Management ACPI; PPMI 1.1 and wake support with PME and Vaux; meets PCI 2.3

requirements and PC 2001 requirements

**Upgradeability** Driver upgradeable for future enhancements

Video ITU-T V.80 video ready interface

Other TIA/EIA 602 standard AT command set

Integrated DTE interface with speeds of up to 115.2 Kbps, parallel 16550a

UART-compatible interface

Optional ring wakeup signal

Operating Temperature 32° to 158° F (0° to 70° C)
Operating Humidity 20% to 90%, non-condensing

Operating System

20% to 90%, non-condensing
Microsoft Windows 2000 and Microsoft Windows XP

Support

OS Driver Support Microsoft Windows 2000 and Microsoft Windows XP

Power Requires a 3.3-V auxiliary power rail on PCI bus



### Technical Specifications - Communications

Uses only one PCI load (i.e., one grant/request pair), one shared IRQ, one

electrical load

Chipset Agere Systems SV92PL – Integrated PCI interface with 5-V tolerant buffers and

CardBus support

Dimensions (L X H) Complies with PCI low profile specifications-6.7 x 2.3 in (17.0 x 5.8 cm) and

supports high- and low-profile brackets

Connection Single RJ-11 connector

Other Features Digital line protection, call progress monitoring via on-board piezo device,

support for high profile and low profile brackets, PnP ID support

Safety UL recognized to UL 1950, 3rd edition (U.S. and Canada); IEC 950 (TUV,

NEMKO, DEMKO, SEMKO); CE Mark, EC 950 (TUV, NEMKO, DEMKO,

SEMKO, CE mark

EMC FCC Part 15, IC ES003, EN 55022, 3rd edition, EN 55024, annex A, EN

61000-4-6, EN 61000-4-8

Telecom FCC Part 68, IC-CS-03 (Canada); Worldwide PTT approvals

Not available in Korea or the Republic of South Africa.

Health Bare PCB material compliant to 94V-0 or better (marked as such)

Other PC 2001 compliant, PCI version 2.3, WHQL approved; ACPI compliant

### Technical Specifications - Graphics

Integrated Graphics				
Media	Acce	lerator	3000	

3D/2D Controller Microsoft DirectX® 9 based with support for Pixel Shader 2.0, 4:1

anisotropic filtering, Gaussian texture filtering, shadow maps, volumetric

textures, double-sided stencil buffers, and 4 pixel pipes.

VGA Controller Integrated

Bus Type PCI Express<sup>™</sup> x16 (If an external graphics card is installed in a PCI slot, the

> internal graphics can be enabled or disabled using the system's BIOS setup utility. If an external graphics card is installed in the PCI Express™ slot, the

internal graphics cannot be enabled).

RAMDAC Integrated, 400 MHz

Memory Graphics memory is shared with system memory. Graphics memory usage

varies depending on the amount of system memory installed and system load. 8 MB is pre-allocated for graphics use at system boot time. Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between

graphics and system memory use.

System memory equal or greater than 512 MB

8 MB pre-allocated + 248 MB DVMT = max frame buffer of 256 MB

Controller Clock Speed 400 MHz

**Overlay Planes** Single overlay support with 5x3 filtering

Maximum Color Depth 32 bits/pixel

Maximum Vertical Refresh 85 Hz at up to 1920x1440, 85 Hz at 2048x1536. Varies with mode and

Rate configuration. See table below.

Multi-display Support Support for one CRT via the motherboard's VGA connector. Support for an

additional DVI-D display via the optional DVI ADD2 card. Dual independent

displays and dual synchronous (Twin or Clone mode) displays are supported.

Operating Systems Microsoft Windows XP and Windows 2000

Graphics/Video API Microsoft DirectX®9, DirectXVA®, VMR9, GDI/GDI+; OpenGL® 1.4.

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Support

Resolutions Supported <sup>1</sup>	Resolution	Maximum Refresh Rate (Hz)	
		Analog Monitor	Digital Monitor
	640 x 480	85	60
	800 x 600	85	60
	1024 x 768	85	60
	1280 x 1024	85	60
	1600 x 1200	85	60
	1920 x 1080	85	60
	1920 x 1200	85	60
	1920 x 1440	85	60

1 Modes listed are supported with a single active display. The supported mode list for multiple active displays is a subset of this list. Not all modes will support video playback and some supported modes may use software MC (motion compensation) rather than hardware MC. Not all modes will support 3D acceleration depending on the system configuration (e.g., resolution selected, size of frame buffer, number of installed memory modules, etc.).

NOTE: Other resolutions and refresh rates may be selectable but are not recommended.

2048 x 1536



60

### Technical Specifications - Graphics

**DVI ADD2 Graphics** 

Models DY674A Intel DVI ADD2 adapter

Form Factor Low-profile card

DVI-D Connector Compliant with DDWG (Digital Display Working Group) and VESA

specifications for a single-link digital DVI (DVI-D) connector.

**Dual Head Support** Yes, when used with the integrated VGA connector

Display Devices HP L1530 Supported HP L1740

HP L1755 HP L1940 HP L1955 HP L2035 HP L2335

**NOTE**: The DVI ADD2 card offers optimal performance with any display that meets applicable VESA standards.

Color Depth All modes support 8-bpp, 16-bpp, and 24-bpp color depths (up to 16.7

million colors)

Host Interface Connector Mechanically compliant with PCI-E standard

Complies with the Intel ADD2 and Intel Serial Digital Video Output (SDVO)

specifications

Dot Clock 165 MHz maximum

Display Modes Supports display modes that require up to 165-MHz bandwidth on the link,

as shown in the following table.

Resolution		60-Hz LCD	60-Hz	75-Hz	85-Hz
Blanking		5% reduced	GTF	GTF	GTF
640 x 480	VGA	Yes	Yes	Yes	Yes
800 x 600	SVGA	Yes	Yes	Yes	Yes
1024 x 768	XGA	Yes	Yes	Yes	Yes
1280 x 1024	SXGA	Yes	Yes	No	No
1600 x 1200	UXGA	Yes	Yes	No	No

ATI Radeon X1300 (256MB SH) PCle Graphics Card Bus Type PCI Express (x16 lanes)

Maximum Vertical Refresh 85 Hz

Rate

Display Support Integrated 400 MHz RAMDAC

Display Max Resolution  $2048 \times 1536$ Board Display Options DVI-I + TV

DVI-I supports analog CRT or flat panel or digital flat panel (using DVI-A,

DVI-D or DVI-I connector)

DVI-I supports analog CRT or flat panel (with VGA connector and DVI-I to

VGA dongle)

TV connector is a 4-pin mini-DIN S-video connector

Board ConfigurationSpecificationDescription128 MB Frame BufferGraphics ChipRV515

Core clock 450 MHz
Memory clock 250 MHz
Frame buffer 256 MB DDR2



Technical Specifications - Graphics

Languages supported 24 languages: English, Arabic, Chinese Simplified, Chinese Traditional,

Czechoslovakian, Danish, Dutch, Finnish, French, German, Greek, Hebrew, Hungarian, Italian, Japanese, Korean, Norwegian, Polish, Portuguese,

Russian, Spanish, Swedish, Thai, Turkish

Operating Systems

Support

Windows 2000, Windows XP

Core Power

25 W (Max board power)

Option kit contents

 ATI RADEON X1300 PCle graphics card with full height bracket attached

Low profile bracketDVI-to-VGA Adapter

• Software CD with graphics drivers

Warranty documentation

Compliance standards

#### **EMC Emissions:**

a) FCC Part 15, Subpart B – Unintentional Radiators, Class B Computing

Devices for Home & Office Use

 b) CISPR22: 1997/EN 55022:1998 – Class B – Limits and methods of measurement of radio disturbance characteristics of Information Technology Equipment

c) Canadian Standard ICES-003 is equivalent to CISPR22

d) Taiwanese Standard BSMI

e) Japanese VCCI

f) Australian C-Tick

**EMC Immunity:** 

CISPR 24:1997/EN 55024:1998 – Information Technology Equipment - Immunity Characteristics – Limits and Methods of Measurement.

Safety:

UL 60950 (USA) & EN 60950 (EU): Safety of Information Technology Equipment, Including Electrical Business Equipment. All boards meet UL PCB

flammability requirements.

ATI Radeon X1300 Pro (256MB DH) PCle Graphics Card

Bus Type

PCI Express (x16 lanes)

Maximum Vertical Refresh 85 Hz

Rate

Display Support

Integrated 400 MHz RAMDAC

Display Max Resolution

2048 x 1536

**Board Display Options** 

Supports 2 displays via included DMS-59 to dual VGA cable or 2 DVI monitors via optional DMS-59 to dual DVI monitor kit #DL139A.

Support TV connection via 7 pin mini Din S-video connector

Board Configuration 128 MB Frame Buffer Specification Description

Graphics Chip RV516
Core clock 600 MHz
Memory clock 400 MHz

Frame buffer 256 MB DDR2 (128 bits wide)

Languages supported

24 languages: English, Arabic, Chinese Simplified, Chinese Traditional, Czechoslovakian, Danish, Dutch, Finnish, French, German, Greek, Hebrew,

Hungarian, Italian, Japanese, Korean, Norwegian, Polish, Portuguese,

Russian, Spanish, Swedish, Thai, Turkish



### Technical Specifications - Graphics

**Operating Systems** 

Support

Windows 2000, Windows XP

Core Power

25 W (Max board power)

Option kit contents

 ATI Radeon X1300 Pro (256MB DH) PCle Graphics Card with full height bracket attached

DMS-59 Dual VGA

NOTE: The Optional DMS-59 DVI cable can be ordered with HP Option Kit #DL139A

Software CD with graphics drivers

Low profile bracket to convert the card for using in a low profile chassis

Warranty documentation

### Compliance standards

#### **EMC Emissions:**

a) FCC Part 15, Subpart B – Unintentional Radiators, Class B Computing Devices for Home & Office Use

b) CISPR22: 1997/EN 55022:1998 – Class B – Limits and methods of measurement of radio disturbance characteristics of Information Technology Equipment

c) Canadian Standard ICES-003 is equivalent to CISPR22

d) Taiwanese Standard BSMI

e) Japanese VCCI

f) Australian C-Tick

g) Korean (MIC)

### **EMC Immunity:**

CISPR 24:1997/EN 55024:1998 – Information Technology Equipment – Immunity Characteristics – Limits and Methods of Measurement.

#### Safety:

UL 60950 (USA) & EN 60950 (EU): Safety of Information Technology Equipment, Including Electrical Business Equipment. All boards meet UL PCB flammability requirements.

### ATI RADEON X1600XT (256 MB DH) FH PCIe **Graphics Card**

**Bus Type** 

PCI Express (x16 lanes)

Maximum Vertical Refresh 85 Hz

Rate

Display Support Integrated 400 MHz RAMDAC

Display Max Resolution 2560 x 1600 digital, 2048 x 1536 analog

**Board Display Options** 2 DVI-I ports (one port supports dual link DVI). DVI-I supports an analog

CRT or flat panel with a VGA connector via the provided DVI-I to VGA

adapter

4-pin mini-DIN S-video connector for TV output

**Board Configuration** 

Specification Description Graphics chip RV530 Core clock 590 MHz Memory clock 690 MHz

Frame buffer 256 MB GDDR3, 128 bit wide

Operating Systems

Support

Windows 2000, Windows XP



Technical Specifications - Graphics

Core Power 56 W (Max board power)

NVIDIA Quadro NVS 280 Form Factor Low profile (both ATX and low profile brackets included) 64MB PCI Dual Head

**Graphic Controller** Integrated Quadro 280 2-D graphics processor unit (GPU)

Bus type PCI

**RAMDAC** Dual 350 MHz integrated

Memory 64 MB DDR with frame buffer and Texture storage

Connector Single High-density DMS-59 Connector Low-profile, 2.586 x 6.6 in (6.57 x 16.76 cm) **Dimensions** 

Controller clock speed 250 MHz

Color depth 32-bits/pixel max

One 16-bit Video overlay plane Overlay planes

Maximum vertical refresh 85 Hz

Multi-monitor support Dual analog or digital monitors

**Dual DVI Support** Yes (with kit DL139A)

High-definition Video Full-screen, full-frame video playback of HDTV and DVD content

Processor (HDVP) DVD-ready motion compensation for MPEG-2

> Independent hardware color controls for video overlay Hardware color-space conversion (YUV 4:2:2 and 4:2:0)

**IDCT** motion compensation

Available graphics drivers Microsoft Windows 2000 and Microsoft Windows XP (Provides full native

Dual View mode, Span or Big Desktop mode, and Clone mode)

NOTE: HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/eng/software drivers.html.

Analog Resolution	Maximum Colors Supported	Maximum Refresh Rate
640 x 480	16.7 M	240 Hz
800 x 600	16.7 M	240 Hz
1024 x 768	16.7 M	200 Hz
1600 x 1200	16.7 M	170 Hz
1600 x 1200	16.7 M	150 Hz
1600 x 1200	16.7 M	100 Hz
1920 x 1200	16.7 M	85 Hz
1920 x 1200	16.7 M	85 Hz
1920 x 1440	16.7 M	75 Hz
2048 x 1536	16.7 M	60 Hz
Digital Resolution	Maximum Colors Supported	Maximum Refresh Rate
640 x 480	16.7 M	75 Hz
800 x 600	16.7 M	75 Hz
1024 x 768	16.7 M	75 Hz
1152 x 864	16.7 M	60 Hz
1280 x 1024	16.7 M	60 Hz
1600 x 1200	16.7 M	60 Hz (primary only)



Technical Specifications - Graphics

NVIDIA Quadro NVS 285 Form Factor (128MB DH) PCle x16 **Graphics Card** 

**Graphic Controller** 

Integrated Quadro 285 2D graphics processor unit (GPU)

**Bus Type PCI-Express** 

Memory 128 MB DDR (64 MB local frame buffer plus 64 MB of system memory via

Low profile, both ATX and low profile brackets included

TurboCache)

Connector DMS-59 to dual-DVI Y-cable or dual-VGA Y-cable **Dimensions** Low-profile, 2.586 x 6.6 in (6.57 x 16.76 cm)

Multi-monitor Support Dual analog or digital monitors

**RAMDAC** Dual 350 MHz (integrated) Maximum Pixel Clock 350 MHz

**Overlay Planes** One 16-bit Video overlay plane

High-definition Video Full screen, full frame video playback of HDTV and DVD content

Processor (HDVP) DVD-ready motion compensation for MPEG-2 Independent hardware color controls for video overlay

Hardware color-space conversion (YUV 4:2:2 and 4:2:0)

IDCT motion compensation

5-tap horizontal by 3-tap vertical filtering

8:1 up/down scaling

**Available Graphics** 

Microsoft Windows 2000 and Microsoft Windows XP (Provides full native **Drivers** 

Dual View mode, Span or Big Desktop mode, and Clone mode)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://www.hp.com/country/us/en/support.html?pageDisplay=drivers

Maximum Colors Supported	Maximum Refresh Rate
16.7 M	240 Hz
16.7 M	240 Hz
16.7 M	240 Hz
16.7 M	170 Hz
16.7 M	150 Hz
16.7 M	100 Hz
16.7 M	85 Hz
16.7 M	85 Hz
16.7 M	75 Hz
16.7 M	60 Hz
Maximum Colors Supported	Maximum Refresh Rate
16.7 M	75 Hz
16.7 M	75 Hz
16.7 M	75 Hz
16.7 M	60 Hz
	16.7 M 16.7 M 16.7 M 16.7 M 16.7 M 16.7 M 16.7 M 16.7 M Maximum Colors Supported 16.7 M 16.7 M 16.7 M 16.7 M 16.7 M 16.7 M

### Technical Specifications - Hard Drives

7200 rpm Serial ATA Hard Drives

250-GB

Capacity 250,059,350,016 bytes

Height 1 in (2.54 cm)

Width Media diameter: 3.5 in (8.89 cm)

Up to 3 Gb/s

Physical size: 4 in (10.2 cm)

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer

Rate (Maximum)

8 MB

Seek Time (typical reads, Single Track 1.0 ms includes controller Average 8.5 ms overhead, including Full-Stroke 18 ms

settling)

Buffer

7,200 rpm Rotational Speed Logical Blocks 488,397,168

41° to 131° F (5° to 55° C) Operating Temperature

160-GB Capacity 163,928,604,672 bytes

> Height 1 in (2.54 cm)

Width Media diameter: 3.5 in (8.89 cm)

Up to 3 Gb/s

Physical size: 4 in (10.2 cm)

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer

Rate (Maximum)

**Buffer** 8 MB

Seek Time (typical reads, Single Track 0.9 ms includes controller 9.3 ms Average overhead, including Full-Stroke 18 ms

settling)

Rotational Speed 7,200 rpm

320,173,056 Logical Blocks

41° to 131° F (5° to 55° C) Operating Temperature

### Technical Specifications - Hard Drives

**80-GB** Capacity 80,026,361,856 bytes

**Height** 1 in (2.54 cm)

Width Media diameter: 3.5 in (8.89 cm)

Physical size: 4 in (10.2 cm)

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer Up to 3 Gb/s

Rate (Maximum)

Buffer 8 MB

Seek Time (typical reads,<br/>includes controller<br/>overhead, including<br/>settling)Single Track<br/>Average2.0 msAverage<br/>Full-Stroke9.3 ms21 ms

Rotational Speed 7,200 rpm Logical Blocks 156,301,488

Operating Temperature  $-41^{\circ}$  to  $131^{\circ}$  F (5° to  $55^{\circ}$  C)



### Technical Specifications - Input/Output Devices

USB Standard Keyboard	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)
		Dimensions (L $\times$ W $\times$ H)	18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2.5 cm)
		Weight	2 lb (0.9 kg) minimum
	Electrical	Operating voltage	$+$ 5VDC $\pm$ 5%
		Power consumption	50-mA maximum (with three LEDs ON)
		System interface	USB Type A plug connector
		ESD	CE level 4, 15-kV air discharge
		EMI – RFI	Conforms to FCC rules for a Class B computing device
		Microsoft® PC 99 – 2001	Functionally compliant
	Mechanical	Languages	38 available
		Keycaps	Low-profile design
		Switch actuation	55-g nominal peak force with tactile feedback
		Switch life	20 million keystrokes (using Hasco modified tester)
		Switch type	Contamination-resistant switch membrane
		Key-leveling mechanisms	For all double-wide and greater-length keys
		Cable length	6 ft (1.8 m)
		Microsoft PC 99 – 2001	Mechanically compliant
		Acoustics	43-dBA maximum sound pressure level
	Environmental	Operating temperature	50° to 122° F (10° to 50° C)
		Non-operating temperature	-22° to 140° F (-30° to 60° C)
		Operating humidity	10% to 90% (non-condensing at ambient)
		Non-operating humidity	20% to 80% (non-condensing at ambient)
		Operating shock	40 g, six surfaces
		Non-operating shock	80 g, six surfaces
		Operating vibration	2-g peak acceleration
		Non-operating vibration	4-g peak acceleration
		Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
		Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence
	Operating system support	pport Windows 2000 and Windows XP	
	Approvals		TUV, TUV GS, VCCI, BSMI, C-Tick, MIC
	Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS  Keyboard, installation guide, warranty card, safety and comfort guide	
	Kit contents		



### Technical Specifications - Input/Output Devices

PS/2 Standard Keyboard	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)
		Dimensions (L $\times$ W $\times$ H)	18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2.5 cm)
		Weight	2 lb (0.9 kg) minimum
	Electrical	Operating voltage	+ 5VDC ± 5%
		Power consumption	50-mA maximum (with three LEDs ON)
		System interface	PS/2 6-pin mini din connector
		ESD	CE level 4, 15-kV air discharge
		EMI – RFI	Conforms to FCC rules for a Class B computing device
		Microsoft PC 99 – 2001	Functionally compliant
	Mechanical	Languages	38 available
		Keycaps	Low-profile design
		Switch actuation	55-g nominal peak force with tactile feedback
		Switch life	20 million keystrokes (using Hasco modified tester)
		Switch type	Contamination-resistant switch membrane
		Key-leveling mechanisms	For all double-wide and greater-length keys
		Cable length	6 ft (1.8 m)
		Microsoft PC 99 – 2001	Mechanically compliant
		Acoustics	43-dBA maximum sound pressure level
	Environmental	Operating temperature	50° to 122° F (10° to 50° C)
		Non-operating temperature	-22° to 140° F (-30° to 60° C)
		Operating humidity	10% to 90% (non-condensing at ambient)
		Non-operating humidity	20% to 80% (non-condensing at ambient)
		Operating shock	40 g, six surfaces
		Non-operating shock	80 g, six surfaces
		Operating vibration	2-g peak acceleration
		Non-operating vibration	4-g peak acceleration
		Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
		Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence
	Operating system support	Microsoft Windows 2000	and Windows XP
	Approvals	UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC ANSI HFS 100, ISO 9241-4, and TUVGS	
	Ergonomic compliance		
	Kit contents	Keyboard, keyboard softward comfort guide	are media, installation guide, warranty card, safety
HP USB Smartcard Keyboard	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)
		Form factor	USB basic Smart Card keyboard
		Colors	Carbonite/Silver



Dimensions  $(H \times W \times D)$ 

Weight

18.2 x 6.3 x 1.3 in (46.3 x 16.1 x 3.3 cm)

2 lb (0.9 kg) minimum

Technical Specifications - Input/Output Devices

Electrical	Operating voltage	$+$ 5VDC $\pm$ 5%
------------	-------------------	-------------------

**Power consumption** 100-mA maximum (with four LEDs ON)

System interface USB Type A plug connector ESD CE level 4, 15-kV air discharge

EMI – RFI Conforms to FCC rules for a Class B computing

device

Microsoft PC 99 - 2001 Functionally compliant

Mechanical Languages 30+ available

Keycaps Low-profile design

Switch actuation 55 g nominal peak force with tactile feedback Switch life 20 million keystrokes (using Hasco modified

tester)

Switch type Contamination-resistant membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Environmental Operating temperature 50° to 122° F (10° to 50° C)

Non-operating  $-22^{\circ}$  to  $140^{\circ}$  F (-30° to 60° C)

temperature

Operating humidity 10% to 90% (non-condensing at ambient)
Non-operating humidity 20% to 80% (non-condensing at ambient)

Operating shock40 g, six surfacesNon-operating shock80 g, six surfacesOperating vibration2-g peak accelerationNon-operating vibration4-g peak acceleration

Drop (out of box)

26 in (66 cm) on carpet, six-drop sequence

Drop (in box)

42 in (107 cm) on concrete, 16-drop sequence

SMARTCARD function Support All ISO 7816 smart cards

Interface Reads from and writes to all ISO7816-1, 2, 3, 4

memory and microprocessor smart cards (T=0,

T=1

Chipset SCM STCII

Standard APIs supported PC/SC, EMV2000, SET

Power USB Port

Short circuit detection (protects smart card and

reader)

Power supply compliant with ISO7816 and EMV

(5V, 60 mA)

Supports 3-V and 5-V cards

**Power consumption** 250-mA maximum draw (50 mA for the

keyboard with three LEDs ON and 200-mA maximum startup current using a high-current,

60-mA smart card)

Technical Specificati	ons - Input/Output	Devices		
		Communication	From card	Programmable from 9,600 baud to 115,200 baud
			From computer	Up to 38,400 baud
		Landing mechanism	Contact device	Friction contact
		J	Card insertions rating Up to 100,000 insertion cycles  USB communications through USB port SCM protocol Automatic card insertion/removal detection	
		Interface modes		
		Reader performance interface	USB connection	
		Electro-magnetic standards	Europe USA	89/336/CEE guideline USAFCC part 15
USB Standard BG1650 Keyboard (gray)	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)	
		Dimensions (L $\times$ W $\times$ H)	18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2. 5 cm)	
		Weight	2 lb (0.9 kg) minimu	m
	Electrical	Operating voltage	$+$ 5VDC $\pm$ 5%	
		Power consumption	50-mA maximum (w	ith three LEDs ON)
		System interface	USB Type A plug connector	
		ESD	CE level 4, 15-kV air discharge	
		EMI – RFI	Conforms to FCC rules for a Class B computin device	
		Microsoft PC 99 – 2001	Functionally compliant	
	Mechanical	Languages	38 available	
		Keycaps	Low-profile design	
		Switch actuation	55-g nominal peak force with tactile feedback	
		Switch life	20 million keystrokes (using Hasco modified tester)	
		Switch type	Contamination-resist	ant switch membrane
		Key-leveling mechanisms	For all double-wide	and greater-length keys
		Cable length	6 ft (1.8 m)	
		Microsoft PC 99 – 2001	Mechanically compli	ant
		Acoustics	43-dBA maximum so	ound pressure level

### Technical Specifications - Input/Output Devices

**Environmental** Operating temperature 50° to 122° F (10° to 50° C)

-22° to 140° F (-30° to 60° C) Non-operating

temperature

Operating humidity 10% to 90% (non-condensing at ambient) Non-operating humidity 20% to 80% (non-condensing at ambient)

40 g, six surfaces Operating shock Non-operating shock 80 g, six surfaces 2-g peak acceleration Operating vibration Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

Operating system support Windows 2000 and Windows XP

UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC, BG **Approvals** 

Prufzert Mark

ANSI HFS 100, ISO 9241-4, and TUVGS Ergonomic compliance

Kit contents Keyboard, installation guide, warranty card, safety and comfort guide

HP PS/2 Scroll Mouse **Dimensions** 3.8 x 6.3 x 11.6 cm (1.5 x 2.5 x 4.6 in)

> Weight 4.44 oz (126 g)

**Environmental** Operating temperature 50° to 122° F (10° to 50° C)

Non-operating temperature

22° to 140° F (-30° to 60° C)

Operating humidity 10% to 90% (non condensing at ambient) 20% to 80% (non condensing at ambient) Non-operating humidity

40 g, 6 surfaces Operating shock Non-operating shock 80 g, 6 surfaces 2 g peak acceleration Operating vibration

Non-operating vibration 4 g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, 6-drop sequence Drop (out of box) 1 m on asphalt tile over concrete, 6-drop

sequence

Electrical 5 VDC ± 10% Operating voltage

> Power consumption 15 mA

PS/2 mini-din connector System consumption

**ESD** CE level 4, 15 kV air discharge

EMI-RFI Conforms to FCC rules for a Class B computing

device

Microsoft Functionally compliant

PC99 - 2001

### Tec

			l l
Technical Specificat	ions - Input/Output D	evices	
	Mechanical	Resolution	400 ± 20% DPI
		Tracking speed	10 in/s (25.4 cm/s) maximum
		Acceleration	100 in/s/s (2.54 m/s/s)
		Switch actuation	65 g nominal peak force
		Switch life	1,000,000 operations (using Hasco modified tester)
		Switch type	Low force micro-switches
		Tracking mechanism life	155 mi (250 km) at average speed of 10 in/s
		Cable length	6 ft (1.8 m)
		Microsoft PC99 – 2001	Mechanically compliant
	Scroll wheel	Width	8 mm
		Diameter	0.99 in (25.2 mm)
		Maximum rotation speed	30 mm/s
		Switch type	Light force micro-switch
		Switch life	1 million operations
		Mechanical life	Minimum 200,000 revolutions
	Regulatory approvals	Compliant	UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC
	Compatibility	Operating system suppor	t Windows 2000 and Windows XP
HP PS/2 Optical Scroll	Dimensions (H x L x W)	3.95 x 6.21 x 11.7 cm (1.56 x 2.44 x 4.61 in)	
Mouse	Weight	4.44 oz (126 g)	
	Environmental	Operating temperature	-32° to 104°F (0° to 40° C)
		Non-operating temperature	-4° to 140°F ( -20° to 60° C)
		Operating humidity	10% to 90% (non condensing at ambient)
		Non-operating humidity	10% to 90% non condensing
		Operating shock	40 g, 6 surfaces
		Non-operating shock	80 g, 6 surfaces
		Operating vibration	2 g peak acceleration
		Non-operating vibration	4 g peak acceleration
		Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face
	Electrical	Operating voltage	5 VDC ± 10%

100mA Power consumption

System consumption PS/2 mini-din connector

**ESD** CE level 4, 15 kV air discharge

EMI-RFI Conforms to FCC rules for a Class B computing

device

Microsoft PC99 - 2001 Functionally compliant



# **QuickSpecs**

### Technical Specifications - Input/Output Devices

Mechanical	Resolution	$400 \pm 20\%$ DPI
	Tracking speed	10 in/s (25.4 cm/s) maximum
	Acceleration	100 in/s/s (2.54 m/s/s)
	Switch actuation	61 g nominal peak force
	Switch life	3,000,000 operations (using Hasco modified tester)
	Switch type	Low force micro-switches
	Tracking mechanism life	155 mi (250 km) at average speed of 10 in/s

Cable length 6 ft (1.8 m)

Microsoft PC99 - 2001 Mechanically compliant

Scroll wheel Width 8 mm

> Diameter 1.01 in (25.6 mm)

Maximum rotation speed 48 rats/sec

Switch type Light force micro-switch Switch life 1 million operations

Mechanical life Minimum 200,000 revolutions

Regulatory approvals Compliant UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI,

BSMI, C-Tick, MIC

Operating system support Windows 2000 and Windows XP Compatibility

**HP USB Optical Scroll** 

Mouse

Dimensions (H x L x W)

 $1.5 \times 4.5 \times 2.5$  in  $(3.8 \times 11.6 \times 6.3 \text{ cm})$ 

0.27 lb (0.12 kg) Weight Cable length 72.8 in (185 cm)

Microsoft Windows 95, 98, 2000, Me, and XP System requirements

Available USB port

### Technical Specifications - Optical Storage

SATA DVD+/-RW
LightScribe Drive

Height 5.25-inch, half-height, tray-load Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc capacity 8.5 GB DL or 4.7 GB standard

Dimensions (W  $\times$  H  $\times$  D) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

Weight (max) 2.6 lb (1.2 kg)

Write speeds DVD+R Up to 16X

> DVD+RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 4X DVD-R Up to 16X DVD-RW Up to 6X CD-R Up to 48X CD-RW Up to 32X

Read speeds DVD-RAM Up to 4X

> DVD+RW, DVD-RW, Up to 8X

DVD+R DL, DVD-R DL

DVD-ROM, DVD+R, Up to 16X

DVD-R

CD-ROM, CD-R Up to 48X CD-RW Up to 32X

Random DVD: < 130 ms (typical), CD: < 120 ms Access time

(typical reads, including (typical)

settling)

Full Stroke DVD: < 240 ms (seek), CD: < 200 ms (seek)

Power Source SATA DC power receptacle

> DC Power Requirement  $5 \text{ VDC} \pm 5\%$ -100 mV ripple p-p

> > $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, 1600 mA

maximum)

12 VDC (< 600 mA typical, 1400 mA

maximum)

Environmental conditions Temperature 41° to 122° F (5° to 50° C)

(operating - non-Relative Humidity 10% to 90% condensing) Maximum Wet Bulb 86° F (30° C)

**Temperature** 

Operating systems

support

Microsoft Windows 2000, Windows XP Professional, Windows XP Home

SATA DVD-ROM Drive Height 5.25-inch, half-height, tray-load

> Orientation Either horizontal or vertical

SATA/ATAPI Interface type

Disc capacity Single layer: Up to 4.7 GB (6 times capacity of CD-ROM)

Double layer: Up to 8.5 GB (12 times capacity of CD-ROM)

Dimensions ( $W \times H \times D$ ) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)



Technical Specifications - Optical Storage

Weight (max)	2.6 lb (1.2 kg)		
Read speeds	DVD+R/-R/+RW/ -RW/+R DL /-R DL	Up to 8X	
	DVD-ROM	Up to 16X	
	DVD-RAM	Up to 4X	
	CD-ROM, CD-R	Up to 48X	
	CD-RW	Up to 32X	
Removable Storage –	Media	Read	Write
Media Compatibility –	CD-ROM	Yes	No
DVD-ROM	CD-R	Yes	No
	CD-RW	Yes	No
	DVD-ROM	Yes	No
	DVD-ROM DL	Yes	No
	DVD-RAM	Yes	No
	DVD+R	Yes	No
	DVD+R DL	Yes	No
	DVD+RW	Yes	No
	DVD-R	Yes	No
	DVD-RW	Yes	No
	DVD-R DL	Yes	No
Access times (typical reads, including	Random	DVD: < 140 ms (typical), CD: < 125 ms (typical)	
setting)	Full Stroke	DVD: < 250 ms (seek), CD: < 210 ms (seek)	
	Cache Buffer	2 MB (minimum)	
	Data Transfer Modes	•	o.7 MB/s); ATA Multi-word MB/s); ATA UltraDMA Mode lt)
Power	Source	SATA DC power receptacle	
	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p	
	DC Current	5 VDC - <1000 mA maximum 12 VDC -< 600 mA maximum	
Environmental	Temperature	41° to 122° F (5° to s	50° C)
(all conditions	Relative Humidity	10% to 90%	
non-condensing)	Maximum Wet Bulb Temperature	86° F (30° C)	
Operating systems support	Microsoft Windows 2000	, Windows XP Professio	nal, Windows XP Home



### Technical Specifications - Optical Storage

SATA CD-RW/DVD-ROM Height

5.25-inch, half-height, tray-load
Combo Drive

Crientation

Fither harizontal or vertical

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc capacity Single layer: Up to 4.7 GB (6 times capacity of CD-ROM)

Double layer: Up to 8.5 GB (12 times capacity of CD-ROM)

Dimensions (W x H x D) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

**Weight** (max) 2.6 lb (1.2 kg)

Write speeds CD-R Up to 48X

CD-RW Up to 32X

 ${\it Read speeds} \qquad {\it DVD+R/-R/+RW/} \qquad {\it Up to 8X}$ 

-RW/+R DL /-R DL

DVD-ROM Up to 16X
CD-ROM, CD-R Up to 48X
CD-RW Up to 32X

(typical reads, including settling) Full Stroke DVD: <

Full Stroke DVD: < 250 ms (typical), CD: < 210 ms

(typical)

**Power** Source SATA DC power receptacle

DC Power Requirement 5 VDC  $\pm$  5%-100 mV ripple p-p

 $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, < 1600 mA

maximum)

12 VDC (< 600 mA typical, < 1400 mA

maximum)

**Environmental** (all Temperature 41° to 122° F (5° to 50° C)

conditions noncondensing) Relative Humidity 10% to 90% Maximum Wet Bulb 86° F (30° C)

**Temperature** 

Operating systems

support

Microsoft Windows 2000, Windows XP Professional, Windows XP Home



### Technical Specifications - Optical Storage

CD-ROM Drive Interface SATA

Data Transfer Rate Variable (Audio CD) – Variable (CD-ROM, CD-R)– 2,400 to 7,200

1,800 to 3,600 KB/s KB/s (48X) Max

(24X) Max

Access Time (ms) Random: <125 ms Full-stroke seek: <210 ms

Data Buffer 2MB

Disk Formats Read CD-ROM Mode 1, CD-ROM XA (Mode 2, Form 1 and 2), CD Digital

Audio, CD-EXTRA, CD-I (Mode 2, Form 1 and 2) and CD-I Ready, CD-Text, CD-Bridge, Photo CD (Single and Multi Session), Video CD, CD-R and CD-

RW Multi-Session

Disk Formats Written None

**Disk Capacity** (CD) 180 MB, 54 0MB, 650 MB, and 700 MB

Block Size Mode 1–2,048, 2,352 bytes

Mode 2–1, 2,048, 2,328, 2,336, 2,340, 2,353 bytes Mode 2–2, 2,328, 2,336, 2,340, 2,352 bytes

CD-DA-2,352, 2,368 bytes

 Diameter
 12 cm; 8 cm

 Thickness
 1.2 mm

 Track Pitch
 1.6 μm

Audio Output Level Line-out-0.7 V @ 47 Kohm

Startup Time <7 seconds (typical); < 30 seconds with multi-session Operating Conditions Temperature 41° to  $122^{\circ}$  F ( $5^{\circ}$  to  $50^{\circ}$  C)

Relative Humidity 10% to 90%

Dimensions ( $H \times W \times D$ ,

maximum)

1.7 x 5.9 x 8.0 in (4.3 x 15.0 x 20.3 cm)

**Weight** 2.6 lb (1200 g)

Operating Systems

Supported

Microsoft Windows 2000, Windows XP Professional, Windows XP Home

PATA DVD+/-RW LightScribe Slim Drive Height 5.25-inch, half-height, tray-load

Orientation Either horizontal or vertical

Interface type ATAPI/EIDE

Disc recording capacity Up to 8.5 GB DL or 4.7 GB standard Dimensions (W  $\times$  H  $\times$  D) 5.0  $\times$  0.5  $\times$  5.0 in (128  $\times$  13.6  $\times$  129 mm)

**Weight** (max) 0.42 lb (190 g)

Write speeds DVD+R Up to 8X

 DVD+RW
 Up to 8X

 DVD+R DL
 Up to 4X

 DVD-R
 Up to 8X

 DVD-RW
 Up to 6X

 CD-R
 Up to 24X

 CD-RW
 Up to 16X

### Technical Specifications - Optical Storage

Read speeds DVD+RW, DVD-RW, Up to 8X DVD-ROM, DVD+R,

DVD-R

DVD-R DL Up to 4X CD-ROM, CD-R Up to 24X CD-RW Up to 24X

Access time

settling)

(typical reads, including

Random

DVD: < 140 ms (typical), CD: < 125 ms

(typical)

Full Stroke DVD: < 250 ms (seek), CD: < 210 ms (seek)

Stop Time < 4 seconds Cache Buffer 2 MB (minimum)

**Data Transfer Modes** ATA PIO mode 4 (16.7 MB/s); ATA Multi-word

DMA mode 2 (16.7 MB/s); ATA UltraDMA Mode

3 (44.4 MB/s – default)

Four-pin, DC power receptacle Power Source

> DC Power Requirement  $5 \text{ VDC} \pm 5\%$ -100 mV ripple p-p

> > $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, 1600 mA

maximum)

12 VDC (< 600 mA typical, 1400 mA

maximum)

**Total Drive Power** < 2.5 Watt

(standby mode)

Audio output Line-Out 0.7 VRMS

> Signal-to-Noise Ratio 74 dB 65 dB Channel Separation

Environmental conditions Temperature

(operating - non-

condensing)

10% to 90% Relative Humidity

Maximum Wet Bulb 86° F (30° C)

**Temperature** 

Operating systems

support

Microsoft Windows 2000, Windows XP Professional, Windows XP Home

41° to 122° F (5° to 50° C)



Technical Specifications - Optical Storage

PATA CD-RW/DVD-ROM Height

12.7mm height slim CD-RW

Combo Slim Drive

Orientation

Fither harizontal or vertical

(typical reads, including

settling)

Orientation Either horizontal or vertical

Interface type PATA/ATAPI

**Disc capacity** Single layer: Up to 4.7 GB (6 times capacity of CD-ROM)

**Dimensions** (W x H x D) 5.0 x 0.5 x 5.0 in (128 x 13.6 x 129 mm)

**Weight** (max) 0.42 lb (190 g)

Write speeds CD-R Up to 24X

CD-RW Up to 24X

Read speeds DVD+R/-R/+RW/ Up to 4X

-RW/+R DL /-R DL

DVD-ROM Up to 8X
CD-ROM, CD-R Up to 24X
CD-RW Up to 24X

Access time Random DVD DVD: < 140 ms (typical), CD: < 125 ms

(typical)

Random CD DVD: < 250 ms (typical), CD: < 210 ms

(typical)

Cache Buffer 2 MB (minimum)

Data Transfer Modes ATA PIO mode 4); ATA Multi-word DMA mode

2; ATA UltraDMA mode 0; ATA UltraDMA mode

1, mode 2; ATA UltraDMA Mode 3 (default)

**Power** Source Four-pin, DC power receptacle

DC Power Requirement 5 VDC  $\pm$  5%-100 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, < 1600 mA

maximum)

**Total Drive Power** < 2.5 Watt

(standby mode)

Audio output level 0.7 Vrms (typical)

Environmental (all Temperature 41° to 122° F (5° to 50° C)

conditions noncondensing)

Relative Humidity

5% to 85%

Maximum Wet Bulb

86° F (30° C)

Temperature (operating)

Operating systems

support

Microsoft Windows 2000, Windows XP Professional, Windows XP Home



### Technical Specifications - Optical Storage

PATA DVD-ROM Slim Drive

Height 12.7mm

Orientation Either horizontal or vertical

Interface type PATA/ATAPI

Dimensions ( $W \times H \times D$ ) 5.0 x 0.5 x 5.0 in (128 x 13.6 x 129 mm)

Weight (max) 0.42 lb (190 g)

Read speeds DVD+R/-R/+RW/ Up to 4X

-RW/+R DL /-R DL

DVD-ROM Up to 8X CD-ROM, CD-R Up to 24X CD-RW Up to 24X

Access time

(typical reads, including

settling)

Random DVD DVD: < 140 ms (typical), CD: < 125 ms

(typical)

DVD: < 250 ms (seek), CD: < 210 ms (seek) Random CD

Data Transfer Modes ATA PIO mode 4 (16.7 MB/s); ATA Multi-word

DMA mode 2 (16.7 MB/s)

Power Source Four-pin, DC power receptacle

> DC Power Requirement  $5 \text{ VDC} \pm 5\%$ -100 mV ripple p-p

DC Current 5 VDC - < 1000 mA typical, < 1600 mA

maximum

**Total Drive Power** < 2.5 Watt

(standby mode)

Audio output Line-Out 0.7 VRMS

> Signal-to-Noise Ratio 74 dB Channel Separation 65 dB

Environmental (all **Temperature** 41° to 122° F (5° to 50° C)

conditions non-Relative Humidity 5% to 85% condensing) Maximum Wet Bulb 86° F (30° C)

Temperature (operating)

Operating systems

support

Microsoft Windows 2000, Windows XP Professional, Windows XP Home



### Technical Specifications - Removable Storage

HP 16-in-1 Media Card Reader USB Interface USB 2.0 High-speed device

Advance protocol support Supports hardware ECC (Error Correction Code) function

Supports hardware CRC (Cyclic Redundancy Check) function

• Supports MS 4-bit parallel transfer mode

• Supports MS-PRO 4-bit parallel transfer mode

• Supports SD 4-bit parallel transfer mode

• Supports high-speed 50-MHz SD 4-bit card (version 1.1)

• Support high-speed 52-MHz MMC 8-bit card

Supported media type with card adapter Mechanical MicroSD (T-Flash)

Memory Stick Micro

Environmental

Operational
Environmental Extremes

Test Parameters/Conditions – Power applied, unit operating on system ±5% nominal supply

voltage.

10°C 10% R.H. = 24 hours 10°C 90% R.H. = 24 hours 20°C 90% R.H. = 24 hours 30°C 90% R.H. = 24 hours 40°C 90% R.H. = 24 hours 50°C 90% R.H. = 24 hours 50°C 10% R.H. = 24 hours

Storage Environmental Extremes

Test Parameters/Conditions 60°C @ 80% R.H. for 96 hours -30°C @ 20% R.H. for 48 hours

No power applied Delta °C < 1.0°C/min Delta % R.H. < 1.5% R.H./min

Operating system support Microsoft Windows 2000 (Service Pack 3 or greater), Windows XP Home,

Windows XP Professional

Approvals USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport

Specification Rev. 1.0, Compliant Intel Front Panel I/O Connectivity Design

Guide V. 1.2

FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUV-T



### Technical Specifications - Environmental Data

#### **Eco-Label Certifications** and declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- US Energy Star
- US Federal Energy Management Program (FEMP)
- Taiwan Green Mark
- China Energy Conservation Program
- IT ECO declaration
- EPEAT Rated SILVER
- Korea Eco-label
- EPEAT
- Japan PC Green label\*

\*NOTE: This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System.'

### Ultra-slim Desktop

### System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Ultraslim Desktop model is based on a typically configured product.

#### **Energy Consumption**

	115 VAC	230 VAC	100 VAC
Normal Operation	105.3 W	103.0 W	106.8 W
Sleep (Energy Star low power mode)	2.74 W	3.00 W	2.76 W
Off	1.58 W	1.85 W	1.57 W
Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	359.3 BTU/hr	351.4 BTU/hr	364.4 BTU/hr
Sleep	9.3 BTU/hr	10.2 BTU/hr	9.4 BTU/hr
Off	5.4 BTU/hr	6.3 BTU/hr	5.4 BTU/hr

\*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

#### **Declared Noise Emissions**

(in accordance with ISO 7779 and ISO 9296)

	Sound Power	Sound Pressure
System Fan Off	(LWAd, bels)	(LpAm, decibels)
Idle	3.9	29
Fixed Disk (random writes)	3.9	30
Optical Drive (sequential reads)	4.9	40



### Technical Specifications - Environmental Data

Longevity and Upgrading This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- Intel LGA775 processor socket
- 8 USB ports
- 1 empty PCI full-height slot (w/ optional PCI riser card), or 1 empty PCle low-profile x16 slot (w/optional PCle riser card)
- 1 internal drive slot
- 1 Slimline optical drive slot
- 3 memory slots
- 1 Serial/Parallel adapter (optional)

Spare parts are available throughout the warranty period and or for up to 5 years after the end of production.

#### **Batteries**

This product complies with ISO standards:

- EU Directive 91/157/EEC
- EU Directive 93/86/EEC
- EU Directive 98/101/EEC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 4000ppm by weight.

Battery size: CR2032 (coin cell)

Battery type: Lithium

#### Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2002/95/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Silver level (see http://www.epeat.net)
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% recycled materials (by wt.)
- This product is 92% recyclable when properly disposed of at end of life.

Packaging Materials	Corrugated Paper	1100 g
	EPE Foam	200 g
	LDPE Bag	23 g

- The EPE foam packaging material is made from 30 to 60% recycled content.
- The corrugated paper packaging materials contains at least 80% recycled content.

#### Small Form Factor



100140

# **QuickSpecs**

### Technical Specifications - Environmental Data

#### System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Small Form Factor Desktop model is based on a typically configured product.

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#### **Energy Consumption**

	115 VAC	230 VAC	100 VAC
Normal Operation	99.0 W	94.0 W	99.5 W
Sleep (Energy Star low power mode)	2.64 W	2.87 W	2.62 W
Off	1.68 W	1.87 W	1.67 W
Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	337.8 BTU/hr	320.7 BTU/hr	339.5 BTU/hr
Sleep	9.0 BTU/hr	9.8 BTU/hr	8.9 BTU/hr
Off	5.7 BTU/hr	6.4 BTU/hr	5.7 BTU/hr

<sup>\*</sup>NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

#### **Declared Noise Emissions**

(in accordance with ISO 7779 and ISO 9296)

	Sound Power	Sound Pressure
System Fan Off	(LWAd, bels)	(LpAm, decibels)
ldle	4.0	29
Fixed Disk (random writes)	4.0	29
Optical Drive (sequential reads)	5.1	41

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Longevity and Upgrading This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- Intel LGA775 processor socket
- 8 USB ports
- 2 empty PCI slots (2 low profile or 2 full-height with optional riser)
- 1 empty PCle x1 slot
- 1 empty PCle x16 slot
- 1 internal drive bay
- 1 SATA optical drive bay
- 1 3.5-inch external drive bay
- 4 memory slots
- 1 second Serial port (optional)

Spare parts are available throughout the warranty period and or for up to 5 years after the end of production.



### Technical Specifications - Environmental Data

#### **Batteries**

This product complies with ISO standards:

- EU Directive 91/157/EEC
- EU Directive 93/86/EEC
- EU Directive 98/101/EEC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 4000ppm by weight.

Battery size: CR2032 (coin cell)

Battery type: Lithium

Drocococ

#### Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2002/95/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Silver level (see http://www.epeat.net)
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% recycled materials (by wt.)
- This product is 91% recyclable when properly disposed of at end of life.

Packaging Materials	Corrugated Paper	1600 g
	EPE Foam	20 g
	LDPE Bag	52 g

• The EPE foam packaging material is made from 30 to 60% recycled content.

Intal Pantium D 015 Processor

• The corrugated paper packaging materials contains at least 80% recycled content.

#### Convertible Minitower

System Configuration

System Comiguration	FIOCESSOI	(3.4-GHz, 2x2MB L2 cache, 800-MHz FSB)
	Memory	1-GB DDR2 Synch Dram PC2-5300 (667-MHz)
	Hard Drive	80-GB SATA 3.0-Gb/s (7200 rpm)
	Optical Drive	SATA DVD-ROM Drive

Communications Integrated Intel 82566DM Gigabit Network Connection, Agere 2006 PCI

56K International SoftModem



### Technical Specifications - Environmental Data

#### **Energy Consumption**

	115 VAC	230 VAC	100 VAC
Normal Operation	87.2 W	87.2 W	91.7 W
Sleep (Energy Star low power mode)	2.38 W	2.88 W	2.34 W
Off	1.01 W	1.45 W	0.98 W
Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	337.8 BTU/hr	320.7 BTU/hr	339.5 BTU/hr
Sleep	9.0 BTU/hr	9.8 BTU/hr	8.9 BTU/hr
Off	5.7 BTU/hr	6.4 BTU/hr	5.7 BTU/hr

\*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

#### **Declared Noise Emissions**

(in accordance with ISO 7779 and ISO 9296)

System Fan Off	Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
Idle	4.0	23
Fixed Disk (random writes)	4.1	24
Optical Drive (sequential reads)	4.9	32

Longevity and Upgrading This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- Intel LGA775 processor socket
- 8 USB ports
- 4 empty full-height PCI slots (2 standard, 2 optional)
- 1 empty full-height PCle x1 slot
- 1 empty full-height PCIe x16 slot
- 2 internal 3.5-inch drive bays
- 3 external 5.25-inch SATA drive bays
- 1 external 3.5-inch drive bay
- 4 memory slots
- 1 second Serial port (optional)

Spare parts are available throughout the warranty period and or for up to 5 years after the end of production.

### Technical Specifications - Environmental Data

#### **Batteries**

This product complies with ISO standards:

- EU Directive 91/157/EEC
- EU Directive 93/86/EEC
- EU Directive 98/101/EEC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 4000ppm by weight.

Battery size: CR2032 (coin cell)

Battery type: Lithium

#### Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2002/95/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Silver level (see http://www.epeat.net)
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% recycled materials (by wt.)
- This product is 97% recyclable when properly disposed of at end of life.

Packaging Materials	Corrugated Paper	1642 g
	EPE Foam	399 g
	LDPE Bag	63 g

- The EPE foam packaging material is made from 30 to 60% recycled content.
- The corrugated paper packaging materials contains at least 80% recycled content.

### Ultra-slim Desktop, Small Form Factor, Convertible Minitower

#### **RoHS Compliance**

Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis. From July 1, 2006, RoHS substances will be virtually eliminated (virtually = to levels below legal limits) for all HP electronic products subject to the RoHS Directive, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive).



### Technical Specifications - Environmental Data

#### Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the

Environment at <a href="http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen-specifications.html">http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen-specifications.html</a>):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

#### **Packaging**

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

### End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/recycle">http://www.hp.com/recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.



### Technical Specifications - Environmental Data

Hewlett-Packard

Information

For more information about HP's commitment to the environment:

Corporate Environmental [link to new HP white paper now in progress]

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html

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